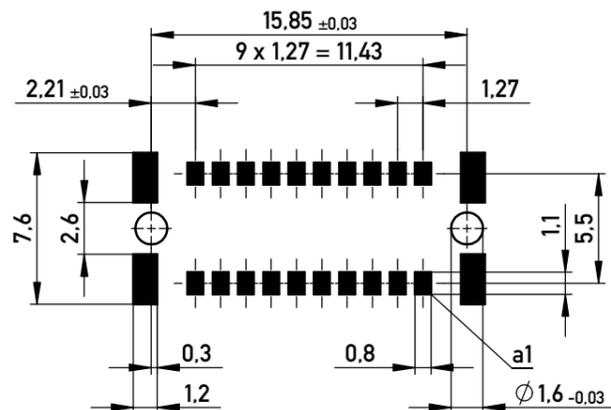


**Leiterplatten-Layout Vorschlag für SMT**  
*PCB-Layout Proposal for SMT*



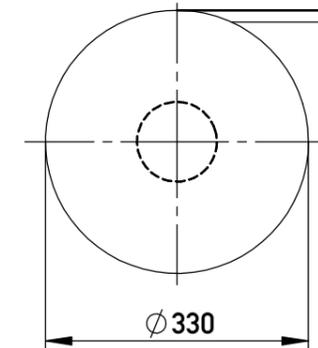
Anforderungsstufe 1  
*Performance Level 1*

Kontaktbereich vergoldet  
*Mating Area gold plating*

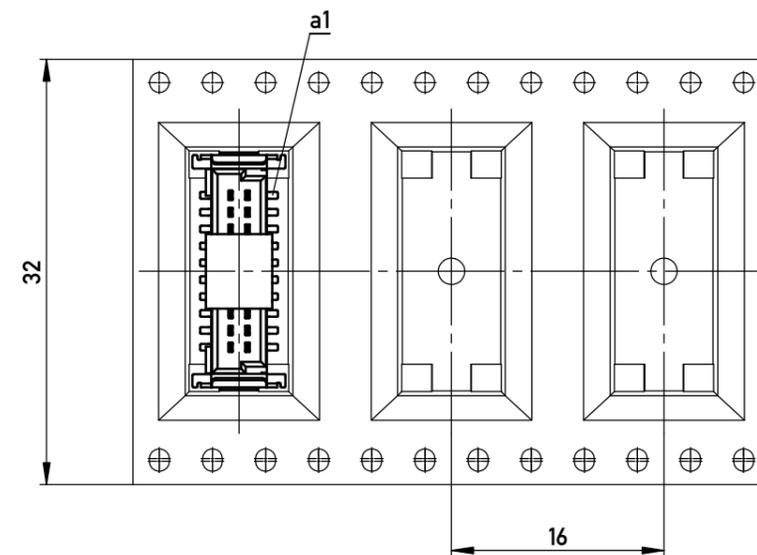
Anschlussbereich verzinkt 4-6 µm  
*Terminal Area 4-6 µm tin plating*

Koplanarität der Anschlüsse ≤ 0.1 mm  
*Coplanarity Area of Termination ≤ 0.1 mm*

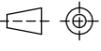
Verpackt im Gurt nach DIN IEC 60286-3  
*Tape on Reel Packaging according to DIN IEC 60286-3*  
Verpackungseinheit: 280 Stück  
*Packaging unit: 280 pcs*



**Abspulrichtung - Reel off Direction** →



BA 8 - 8mm Bauhöhe  
*type 8-13 - Low Profile*

Information:  All rights reserved. Only for Information. To ensure that this is the latest version of this drawing, please contact one of the ERNI companies before using.	Tolerances  All Dimensions in mm	Scale <b>3:1</b>	Designation <b>Messerl. SMC-Q 20-SMD-BA8-13</b> <b>Male SMC-Q 20-SMD-type8-13</b>
	Subject to modification without prior notice. Drawing will not be updated.	 www.ERNI.com	<b>254588</b> I A3
e Index	14.07.2015 Date	Class SMCQ	

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